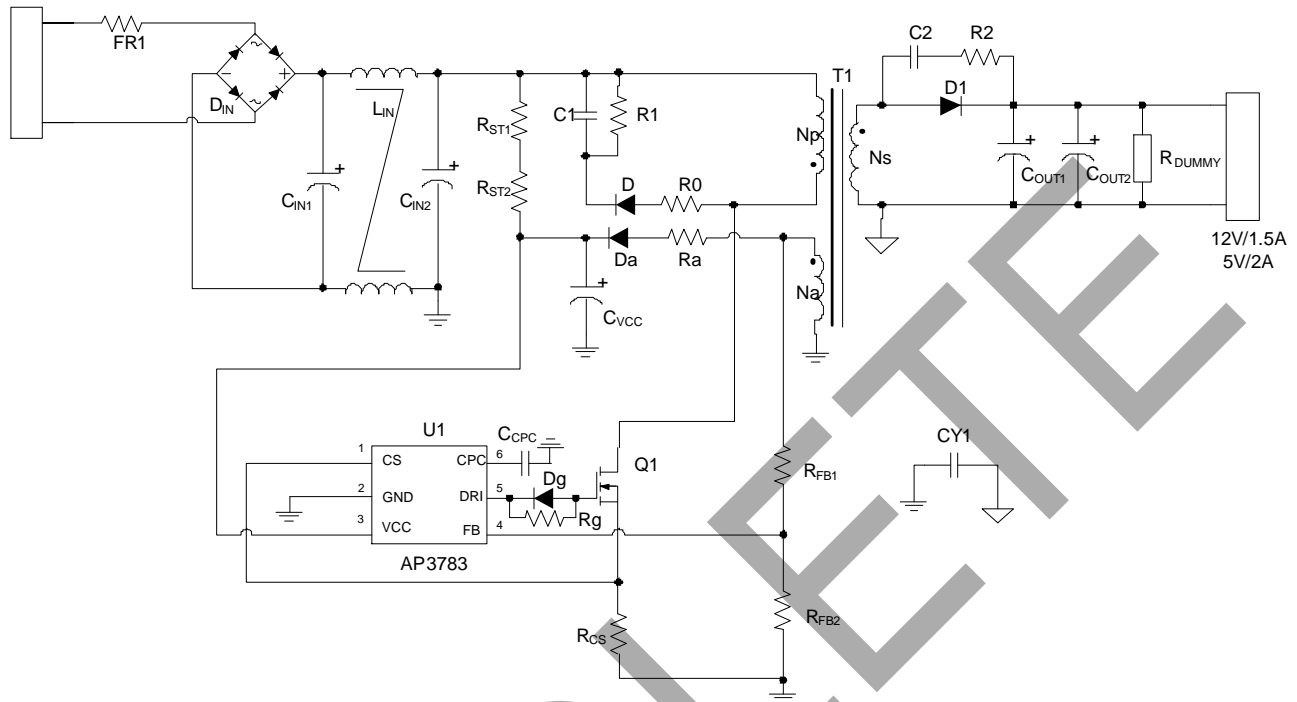


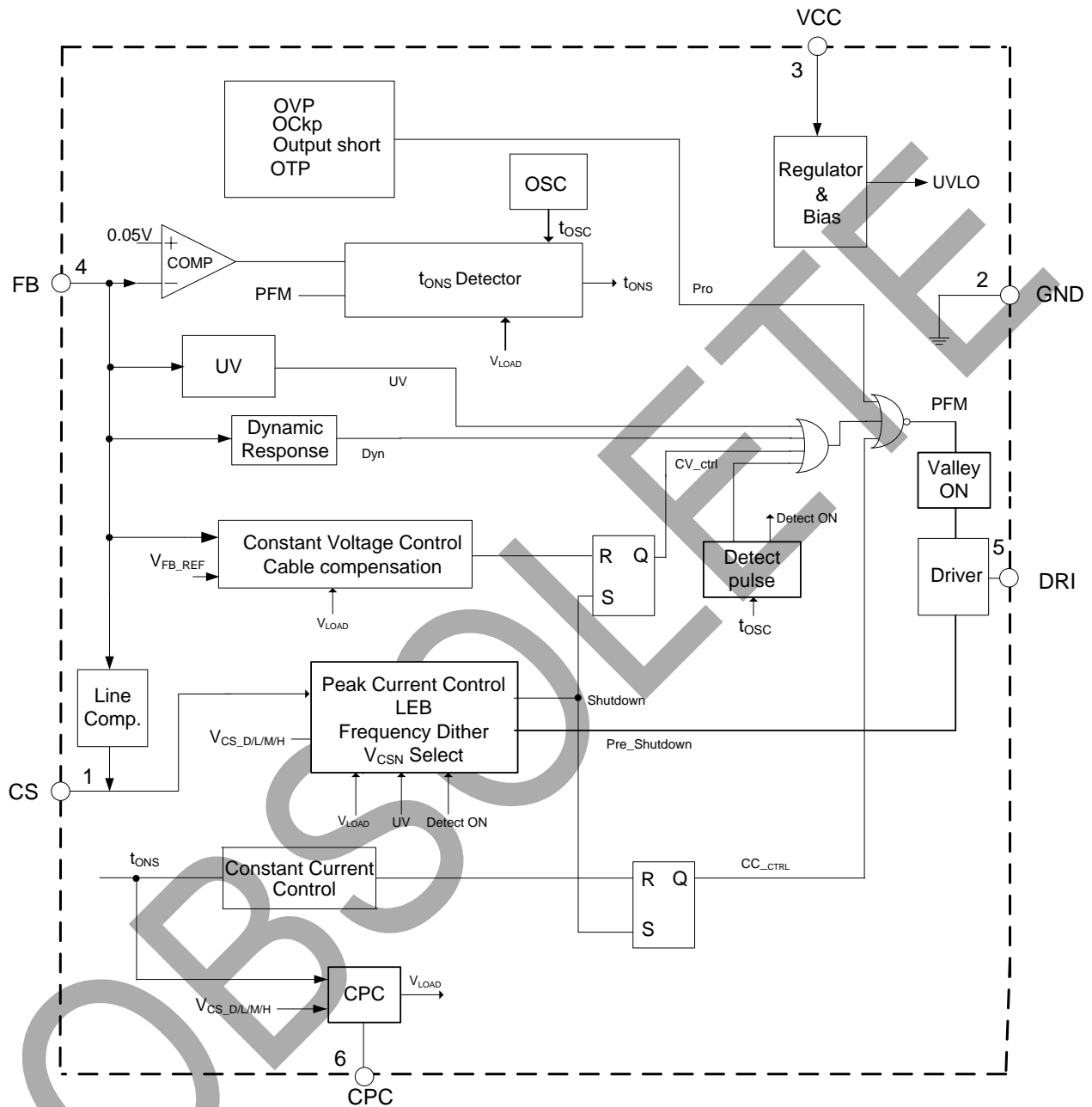
## Typical Applications Circuit



## Pin Descriptions

Pin Number	Pin Name	Function
1	CS	The CS is the current sense pin of the IC. The IC will turn off the power MOSFET according to the voltage on the CS pin
2	GND	The ground of the controller
3	VCC	The VCC pin supplies the power for the IC. In order to get the correct operation of the IC, a capacitor with low ESR should be placed as close as possible to the VCC pin
4	FB	The CV and CC regulation are realized based on the voltage sampling of this pin
5	DRI	Output pin to drive external MOSFET
6	CPC	A capacitor about 50nF should be connected to this pin. The voltage of CPC pin is linear to load of the system and it is used for the functions of cable voltage drop compensation and audio noise suppression

# Functional Block Diagram



**Absolute Maximum Ratings** (Note 4)

Symbol	Parameter	Rating	Unit
V <sub>CC</sub>	Supply Voltage	-0.3 to 35	V
V <sub>CS</sub> , V <sub>CPC</sub>	Voltage on CS, CPC Pin	-0.3 to 7	V
V <sub>FB</sub>	FB Input Voltage	-0.4 to 10	V
I <sub>SOURCE</sub>	Source Current from OUT Pin	Internally Limited	A
T <sub>J</sub>	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
T <sub>LEAD</sub>	Lead Temperature (Soldering, 10 sec)	+300	°C
θ <sub>JA</sub>	Thermal Resistance (Junction to Ambient)	200	°C/W
ESD	ESD (Human Body Model)	6000	V
	ESD (Charged Device Model)	400	V

Notes: 4. Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.

**Electrical Characteristics** (@V<sub>CC</sub> = 15V, T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameters	Conditions	Min	Typ	Max	Unit
STARTUP AND UVLO SECTION						
V <sub>TH_ST</sub>	Startup Threshold	—	13	15.5	18	V
V <sub>OPR(MIN)</sub>	Minimal Operating Voltage	—	6	6.8	7.6	V
STANDBY CURRENT SECTION						
I <sub>ST</sub>	Startup Current	V <sub>CC</sub> = V <sub>TH_ST</sub> - 1V before startup	0	0.2	0.6	μA
I <sub>CC_OPR</sub>	Operating Current	Static current @ no load	300	450	600	
DRIVING OUTPUT SECTION						
V <sub>GATE</sub>	Gate Voltage	—	12	13	14	V
I <sub>SOURCE_L</sub>	Low Driver Source Current	—	17.5	20	22.5	mA
I <sub>SOURCE_H</sub>	High Driver Source Current	—	100	110	120	mA
V <sub>TH</sub>	High/Low Driver Source Current Threshold Voltage	—	6	6.5	7	V
R <sub>SINK</sub>	Sink Resistance	—	5.5	6.5	7.5	Ω

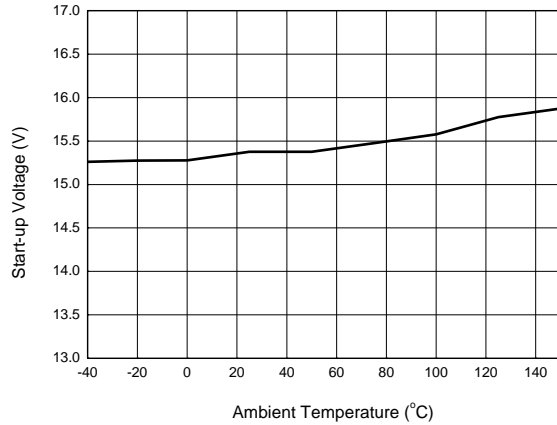
**Electrical Characteristics** (Cont.) (@V<sub>CC</sub> = 15V, T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameters	Conditions	Min	Typ	Max	Unit
OPERATING FREQUENCY SECTION						
f <sub>S</sub> (MAX)	The Maximum Operating Frequency	I <sub>O</sub> (MAX) (Note 5)	–	–	60	kHz
t <sub>OFF</sub> (MAX)	Maximum Off Time		691	768	845	μs
t <sub>SAMPLE_H</sub>	Sample Time	57% to 100% I <sub>O</sub> (MAX)	5.2	5.8	6.4	μs
t <sub>SAMPLE_M</sub>		34% to 57% I <sub>O</sub> (MAX) (Note 6)	4.3	4.8	5.3	μs
t <sub>SAMPLE_L</sub>		5.5% to 34% I <sub>O</sub> (MAX) (Note 6)	2.7	3	3.3	μs
t <sub>SAMPLE_D</sub>		0% to 5.5% I <sub>O</sub> (MAX) (Note 6)	1.5	1.7	1.9	μs
FREQUENCY JITTER SECTION						
ΔV <sub>CS</sub> /V <sub>CS</sub>	V <sub>CS</sub> Modulation	5.5% load to 100% I <sub>O</sub> (MAX)	4.5	5	5.5	%
f <sub>MOD</sub>	V <sub>CS</sub> Modulation Frequency	5.5% load to 100% I <sub>O</sub> (MAX)	3.6	4	4.4	kHz
CURRENT SENSE SECTION						
V <sub>CS_H</sub>	Peak Current Sense Threshold Voltage	57% to 100% I <sub>O</sub> (MAX)	828	900	972	mV
V <sub>CS_M</sub>	As Above	34% to 57% I <sub>O</sub> (MAX) (Note 6)	690	750	810	mV
V <sub>CS_L</sub>	As Above	5.5% to 34% I <sub>O</sub> (MAX) (Note 6)	414	450	486	mV
V <sub>CS_D</sub>	As Above	0% to 5.5% I <sub>O</sub> (MAX) (Note 6)	230	250	270	mV
R <sub>LINE</sub>	Built-in Line Compensation Resistor	(Note 7)	245	260	275	Ω
t <sub>LEB</sub>	Leading Edge Blanking	V <sub>CS</sub> (Note 6)	495	550	605	ns
CONSTANT VOLTAGE SECTION						
V <sub>FB</sub>	Feedback Voltage	Closed loop test of V <sub>OUT</sub>	3.95	4.01	4.07	V
R <sub>FB</sub>	FB Pin Input Resistance	V <sub>FB</sub> =4V	560	700	840	kΩ
V <sub>CABLE</sub> /V <sub>OUT</sub> %	Cable Compensation Ratio	AP3783A	6	7	8	%
		AP3783B	3	4	5	%
		AP3783C	10	12	14	%
CONSTANT CURRENT SECTION						
t <sub>ONS</sub> /t <sub>SW</sub>	Secondary Winding Conduction Duty	V <sub>FB</sub> = 3.5V	0.47	0.5	0.53	–
VALLEY-ON SECTION						
t <sub>VAL-ON</sub>	Valid Off Time of Valley-on	From the end of t <sub>ONS</sub>	14.4	16	17.6	μs
DYNAMIC SECTION						
V <sub>UV_H</sub>	Under Voltage of FB Pin for V <sub>CS_H</sub>	–	3.61	3.68	3.75	V
PROTECTION FUNCTION SECTION						
V <sub>FB</sub> (OVP)	Over Voltage Protection at FB Pin	–	7.1	7.5	7.9	V
V <sub>CC</sub> (OVP)	Over Voltage Protection at V <sub>CC</sub> Pin	–	28	30	32	V
t <sub>ONP</sub> (MAX)	Maximum Turn-on Time	–	13.5	16	25	μs
V <sub>FB</sub> (SCP)	Short Circuit Protection	V <sub>FB</sub> @ Hiccup	2.45	2.6	2.75	V
t <sub>SCP</sub>	Maximum Time under V <sub>FB</sub> (SCP)	–	115	128	141	ms
T <sub>OTP</sub>	Shutdown Temperature	–	+144	+160	+176	°C
T <sub>HYS</sub>	Temperature Hysteresis	–	+36	+40	+44	°C

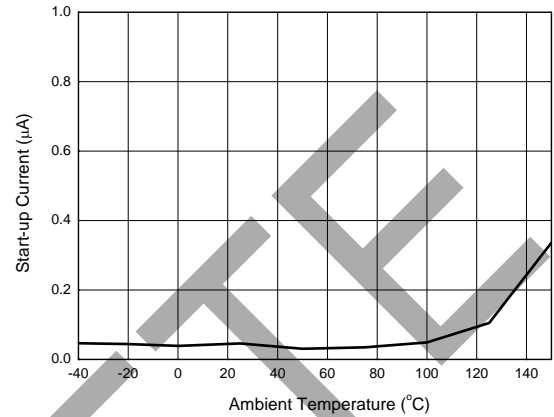
- Notes:
- The output constant-current design value, generally set to 110% to 120% of full load.
  - Guaranteed by Design.
  - Line compensation voltage on CS reference:  $\Delta V_{CS\_REF} = 0.438 \times \frac{R_{LINE}}{R_{FB1} + R_{LINE}} \times V_{AUX}$

## Performance Characteristics

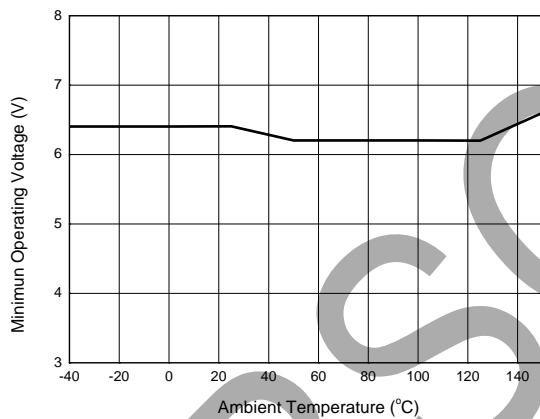
Start-up Voltage vs. Ambient Temperature



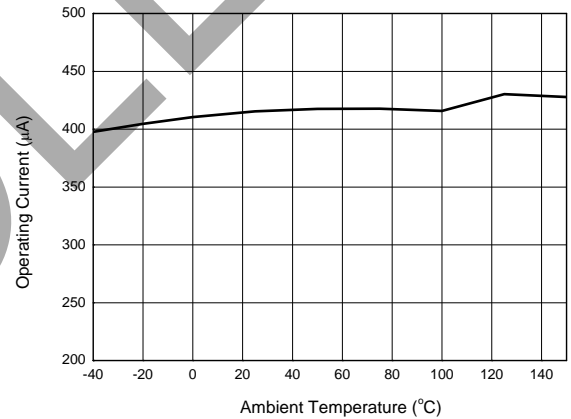
Start-up Current vs. Ambient Temperature



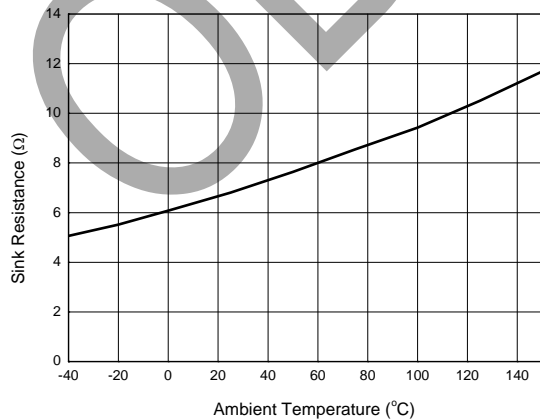
Minimal Operating Voltage vs. Ambient Temperature



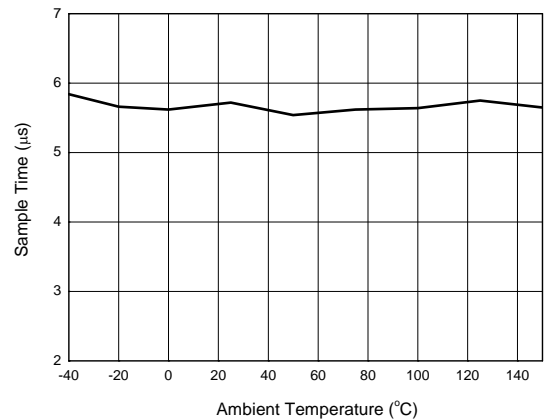
Operating Current vs. Ambient Temperature



Sink Resistance vs. Ambient Temperature

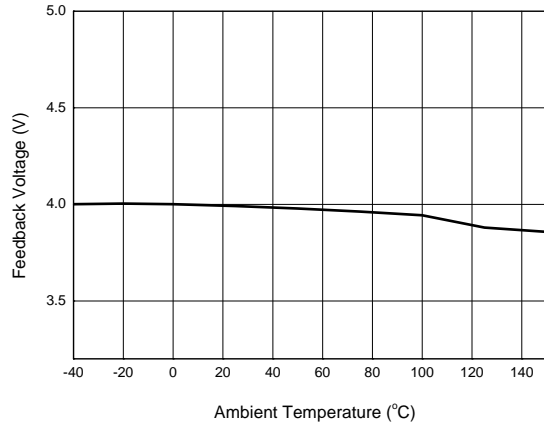


Sample Time vs. Ambient Temperature

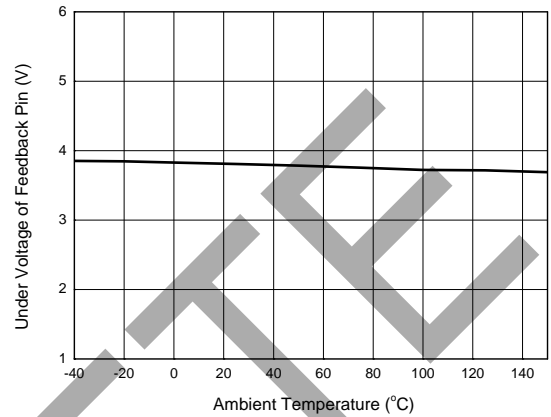


**Performance Characteristics (Cont.)**

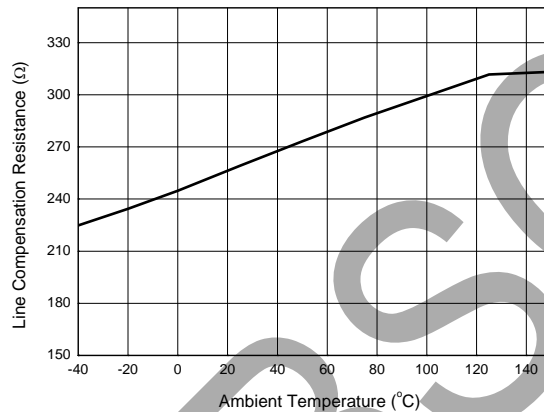
**Feedback Voltage vs. Ambient Temperature**



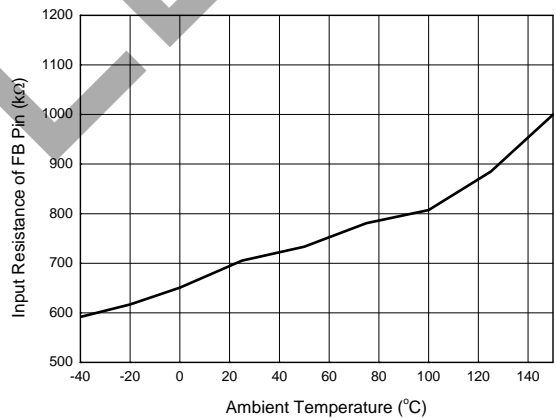
**Under Voltage of FB Pin vs. Ambient Temperature**



**Line Compensation Resistance vs. Ambient Temperature**



**Input Resistance of FB Pin vs. Ambient Temperature**



OBsolete - PART DISCONTINUED

## Operation Principle Description

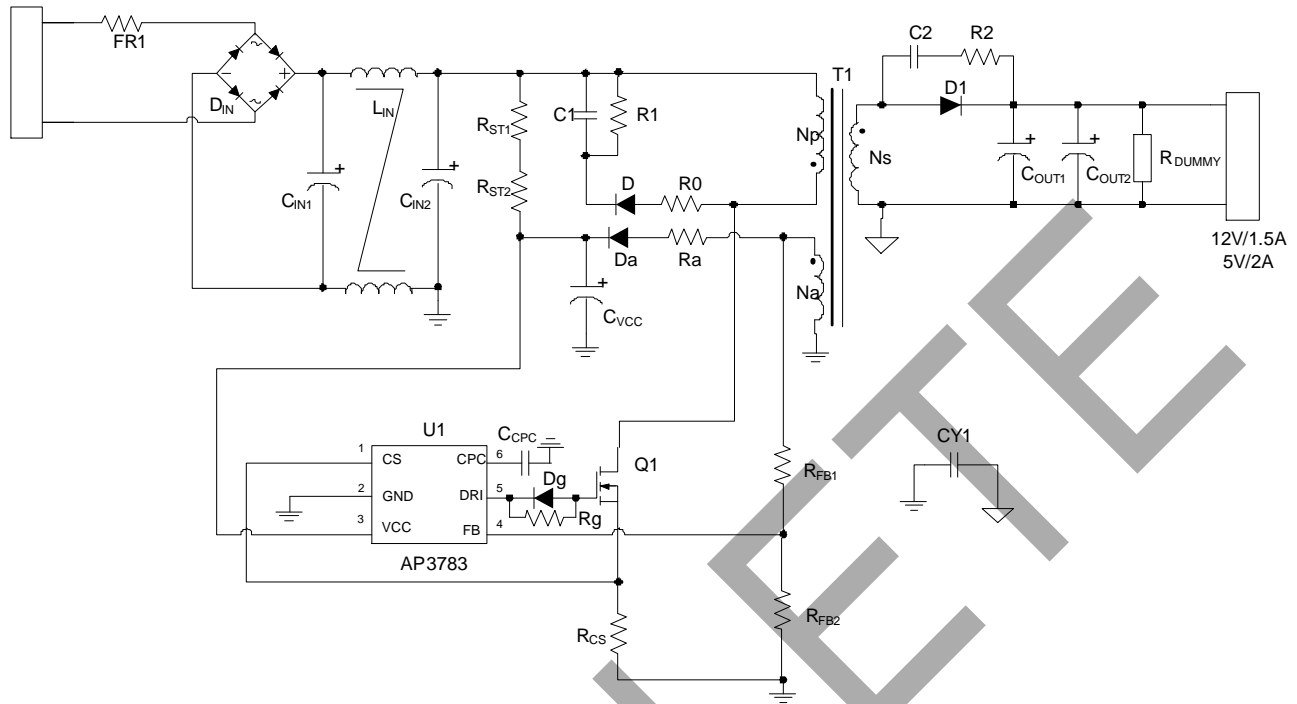


Figure 1. Typical Application Circuit of AP3783

Figure 1 is the typical application circuit of AP3783, which is a conventional Flyback converter with a 3-winding transformer---primary winding ( $N_p$ ), secondary winding ( $N_s$ ) and auxiliary winding ( $N_{aux}$ ). The auxiliary winding is used for providing VCC supply voltage for IC and sensing the output voltage feedback signal to FB pin.

Figure 2 shows the typical waveforms which demonstrate the basic operating principle of AP3783 application. And the parameters are defined as following.

$I_p$ ---The primary side current

$I_s$ ---The secondary side current

$I_{PK}$ ---Peak value of primary side current

$I_{PKS}$ ---Peak value of secondary side current

$V_{SEC}$ ---The transient voltage at secondary winding

$V_s$ ---The stable voltage at secondary winding when rectification diode is in conducting status, which equals the sum of output voltage  $V_{OUT}$  and the forward voltage drop of diode

$V_{AUX}$ ---The transient voltage at auxiliary winding

$V_A$ --- The stable voltage at auxiliary winding when rectification diode is in conducting status, which equals the sum of voltage VCC and the forward voltage drop of auxiliary diode

$t_{sw}$  ---The period of switching frequency

$t_{ONP}$  ---The conduction time when primary side switch is "ON"

$t_{ONS}$  ---The conduction time when secondary side diode is "ON"

$t_{OFF}$  ---The dead time when neither primary side switch nor secondary side diode is "ON"

$t_{OFFS}$  --- The time when secondary side diode is "OFF"

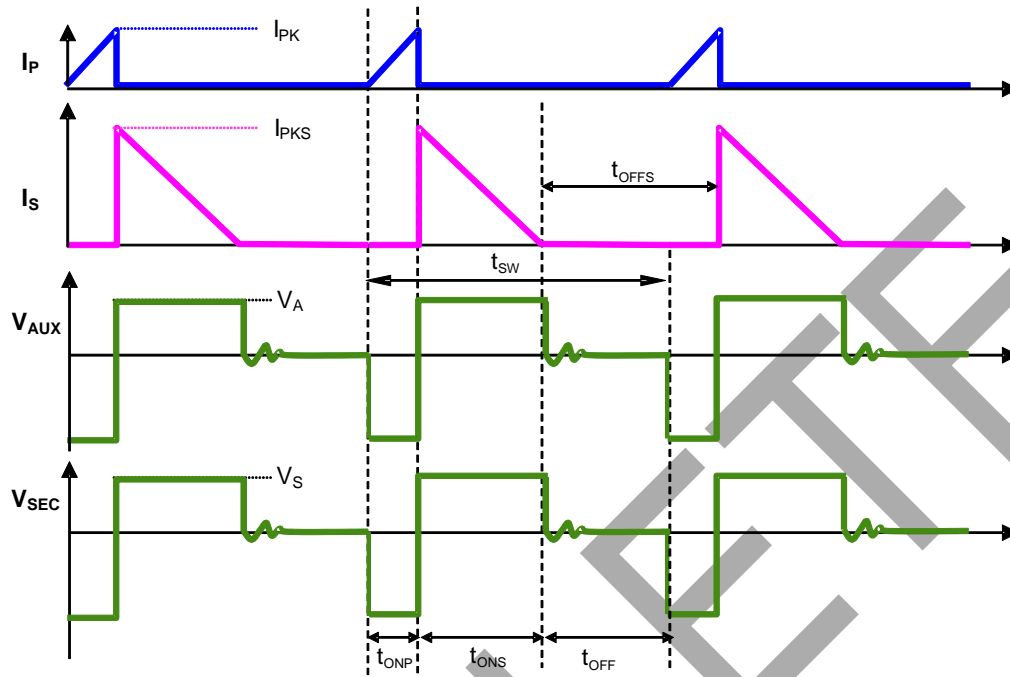
**Operation Principle Description (Cont.)**


Figure 2. The Operation Waveform of Flyback PSR System

For primary-side regulation, the primary current  $i_p(t)$  is sensed by a current sense resistor  $R_{CS}$  (as shown in Figure 1). The current rises up linearly at a rate of:

$$\frac{di_p(t)}{dt} = \frac{V_{IN}(t)}{L_M} \quad (1)$$

As illustrated in Figure 2, when the current  $i_p(t)$  rises up to  $I_{PK}$ , the switch Q1 turns off. The constant peak current is given by:

$$I_{PK} = \frac{V_{CS}}{R_{CS}} \quad (2)$$

The energy stored in the magnetizing inductance  $L_M$  each cycle is therefore:

$$E_g = \frac{1}{2} \times L_M \cdot I_{PK}^2 \quad (3)$$

So the power transferring from the input to the output is given by:

$$P = \frac{1}{2} \times L_M \times I_{PK}^2 \times f_{SW} \quad (4)$$

Where, the  $f_{SW}$  is the switching frequency. When the peak current  $I_{PK}$  is constant, the output power depends on the switching frequency  $f_{SW}$ .

**Constant Voltage Operation**

As to constant-voltage (CV) operation mode, the AP3783 detects the auxiliary winding voltage at FB pin to regulate the output voltage. The auxiliary winding voltage is coupled with secondary side winding voltage, so the auxiliary winding voltage at D1 conduction time is:

$$V_{AUX} = \frac{N_{AUX}}{N_S} \times (V_O + V_D) \quad (5)$$

Where the  $V_D$  is the diode forward voltage drop.



## Operation Principle Description (Cont.)

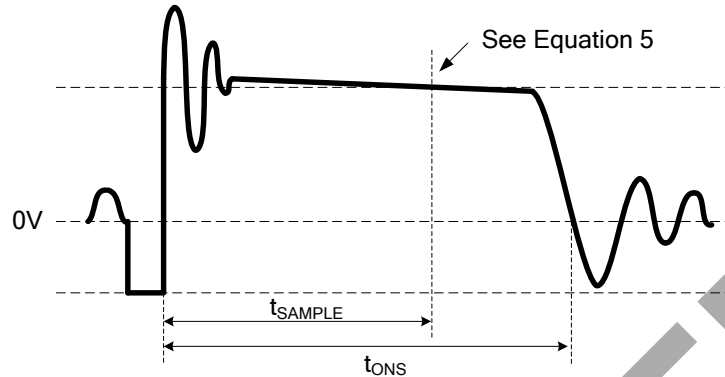


Figure 3. Auxiliary Voltage Waveform

The voltage detection point is at a constant delay time of the D1 on-time. The constant delay time is changed with the different primary peak current. The CV loop control function of AP3783 then generates a D1 off-time to regulate the output voltage.

### Constant Current Operation

The AP3783 can work in constant-current (CC) mode. Figure 2 shows the secondary current waveforms.

In CC operation mode, the CC control loop of AP3783 will keep a fixed proportion between D1 on-time  $t_{ONS}$  and D1 off-time  $t_{OFFS}$ . The fixed proportion is

$$\frac{t_{ONS}}{t_{OFFS}} = \frac{4}{4} \quad (6)$$

The relationship between the output current and secondary peak current  $I_{PKS}$  is given by:

$$I_{OUT} = \frac{1}{2} \times I_{PKS} \times \frac{t_{ONS}}{t_{ONS} + t_{OFFS}} \quad (7)$$

As to tight coupled primary and secondary winding, the secondary peak current is

$$I_{PKS} = \frac{N_P}{N_S} \times I_{PK} \quad (8)$$

Thus the output constant-current is given by:

$$I_{OUT} = \frac{1}{2} \times \frac{N_P}{N_S} \times I_{PK} \times \frac{t_{ONS}}{t_{ONS} + t_{OFFS}} = \frac{2}{8} \times \frac{N_P}{N_S} \times I_{PK} \quad (9)$$

Therefore, AP3783 can realize CC mode operation by constant primary peak current and fixed diode conduction duty cycle.

### Multiple Segment Constant Peak Current

As to the original PFM PSR system, the switching frequency decreases with output current decreasing, which will encounter audible noise issue since switching frequency decreases to audio frequency range, about less than 20kHz.

In order to avoid audible noise issue, AP3783 uses 4-segment constant primary peak current control method. At constant voltage mode, the current sense threshold voltage is multiple segments with different loading, as shown in Figure 4, which are  $V_{CS\_H}$  for high load,  $V_{CS\_M}$  for medium load,  $V_{CS\_L}$  for light load and  $V_{CS\_D}$  for ultra light load. At constant current mode, the peak current is still  $V_{CS\_H}$ .

## Operation Principle Description (Cont.)

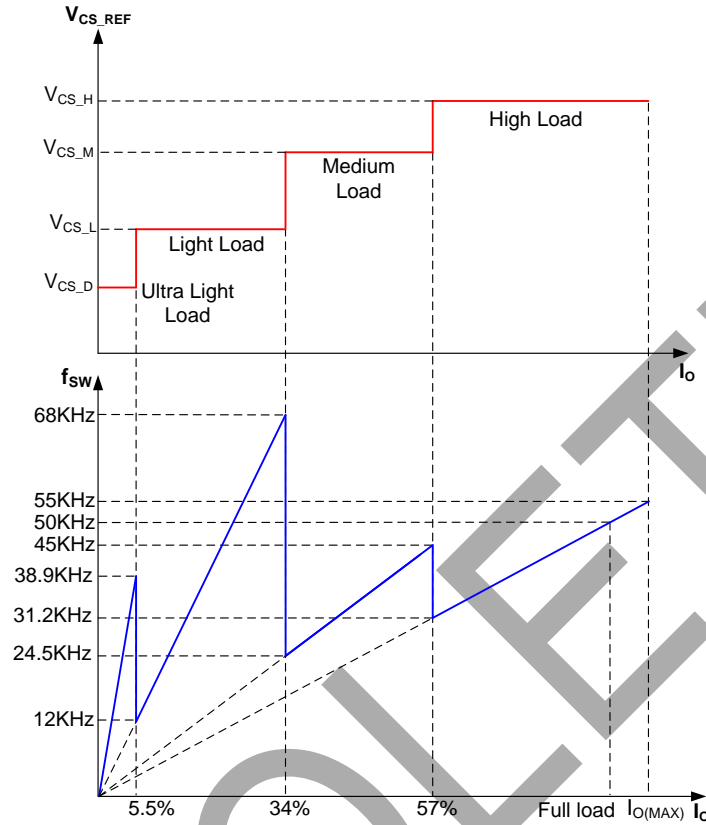


Figure 4. Multiple Segment Peak Current at CV Mode

It can be seen from Figure 4, with multiple segment peak current control, AP3783 power system can achieve good audible noise performance.

### 3-Segment Drive Current for Radiative EMI Suppression

When the power switch is turned on, a turn-on spike will occur, that worsens the radiative EMI. It is an effective way to decrease drive current before gate voltage gets to miller platform. The AP3783 uses 3-segment drive current for radiative EMI suppression, as shown in Figure 5. When gate voltage gets to 6V, the AP3783 drive current switches from low current (typical: 20mA) to high current (typical: 110mA). When the gate voltage gets to 10V, the drive current will decrease gradually to 0mA until the gate voltage goes up to the clamp voltage (13V).

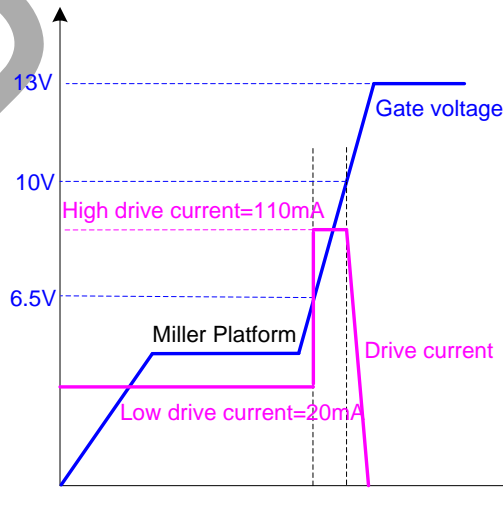


Figure 5. Drive Current and Gate Voltage

## Operation Principle Description (Cont.)

### Leading Edge Blanking (LEB) Time

When the power switch is turned on, a turn-on spike will occur on the sense-resistor. To avoid false turn off switch, a leading-edge blanking is built in. During this blanking time, the current sense comparator is disabled and the external power switch cannot be turned off. Furthermore, due to multiple segment peak current design, the required maximum on time  $t_{ONP}$  changes with different load conditions. Therefore the LEB time parameter also changes with different load conditions.

### Adjustable Line Compensation and Fixed Cable Compensation

The AP3783 power system can adjust line compensation by changing the upper resistor at FB pin. The line compensation capability is increased by decreasing the resistance of the upper FB resistor.

Cable compensation is fixed in AP3783.

### Valley Turn-on

When the off time ( $t_{OFF}$ ) is lower than  $16\mu s$ , AP3783 power system can work with valley turn-on. It can reduce MOSFET switching on power losses which is resulted from the equivalent output capacitance. At the same time, because of valley turn-on the switching frequency has the random jitter feature, which will be benefited for conductive EMI performance. And valley turn-on can also reduce the power switch turn-on spike current and then result in the better radiative EMI performance.

### Frequency Jitter

Even though the valley turn on function can lead the random frequency jitter feature, an active frequency jitter function is added to AP3783 to ensure the frequency jitter performance in the whole loading condition. By adjusting the  $V_{CS\_REF}$  with deviation of 5.0% every  $256\mu s$  cycle, the active frequency jitter can be realized.

### Short Circuit Protection (SCP)

Short Circuit Protection (SCP) detection principle is similar to the normal output voltage feedback detection by sensing FB pin voltage. When the detected FB pin voltage is below  $V_{FB(SCP)}$  for a duration of about 128ms, the SCP is triggered. Then the AP3783 enters hiccup mode that the IC immediately shuts down and then restarts, so that the  $V_{CC}$  voltage changes between  $V_{TH\_ST}$  and UVLO threshold until  $V_{FB(SCP)}$  condition is removed.

As to the normal system startup, the time duration of FB pin voltage below  $V_{FB(SCP)}$  should be less than 18ms to avoid entering SCP mode. But for the output short condition or the output voltage below a certain level, the SCP mode will be triggered.

Figure 6 is the AP3783 normal start-up waveform that the voltage of FB pin is above  $V_{FB(SCP)}$  during  $t_{SCP}$  after  $V_{CC}$  gets to the  $V_{TH\_ST}$ , which doesn't enter the SCP mode. As shown in Figure 7,  $V_{OUT}$  is short and the voltage of FB pin is lower than  $V_{FB(SCP)}$  during  $t_{SCP}$ , the AP3783 triggers the SCP and enters the hiccup mode.

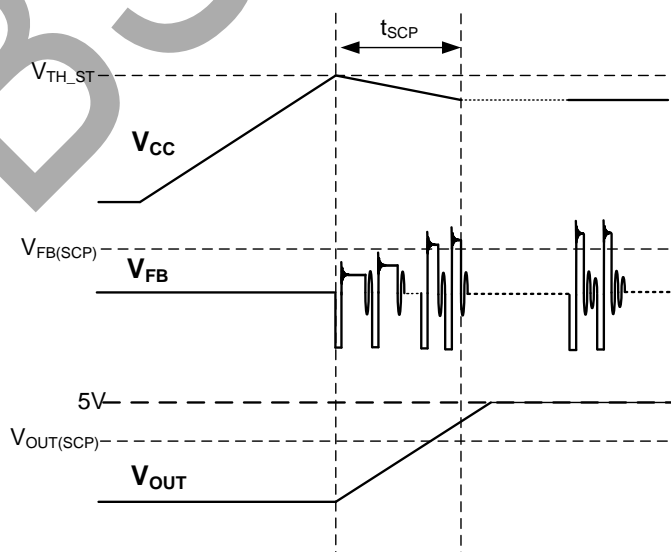


Figure 6. Normal Start-up

## Operation Principle Description (Cont.)

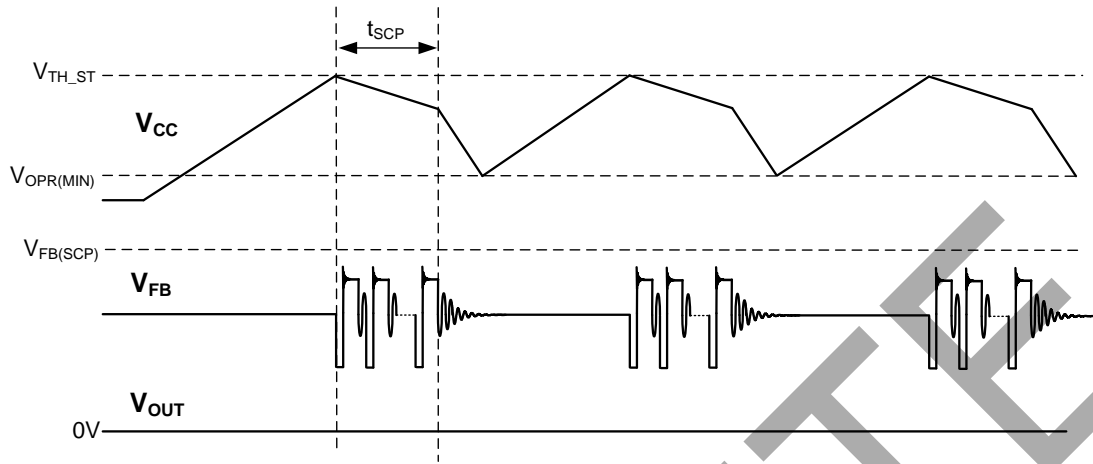


Figure 7. Short Circuit Protection (SCP) and Hiccup Mode

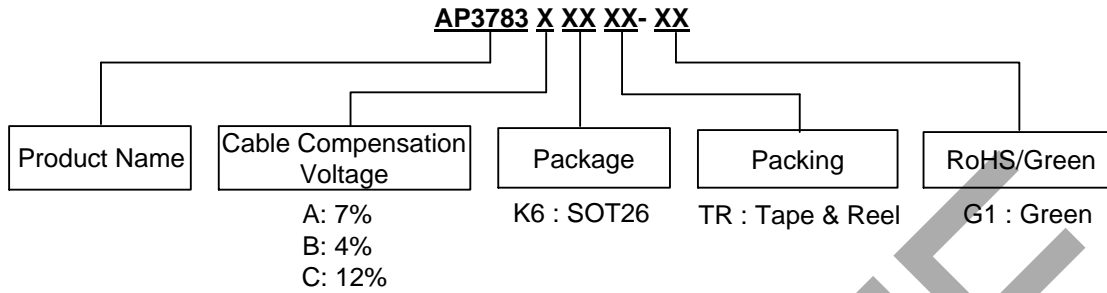
### OVP

The AP3783 includes output over-voltage protection (OVP). If the voltage at FB pin exceeds  $V_{FB(OVP)}$ , the AP3783 immediately shuts down and keeps the internal circuitry enabled to discharge the VCC capacitor to the UVLO turn-off threshold. After that, the device returns to the start state and a start-up sequence ensues.

### OTP

If the junction temperature reaches the threshold of  $+160^{\circ}\text{C}$ , AP3783 shuts down immediately. Before VCC voltage decreases to UVLO, if the junction temperature decreases to  $+120^{\circ}\text{C}$ , AP3783 can recover to normal operation. If not, the power system enters restart Hiccup mode until the junction temperature decreases below  $+120^{\circ}\text{C}$ .

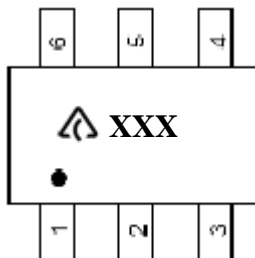
## Ordering Information



Package	Temperature Range	Cable Compensation Voltage	Part Number	Marking ID	Packing
SOT26	-40 to +85°C	7%	AP3783AK6TR-G1	GBZ	3000/Tape & Reel
		4%	AP3783BK6TR-G1	GNZ	3000/Tape & Reel
		12%	AP3783CK6TR-G1	GPZ	3000/Tape & Reel

## Marking Information

(Top View)

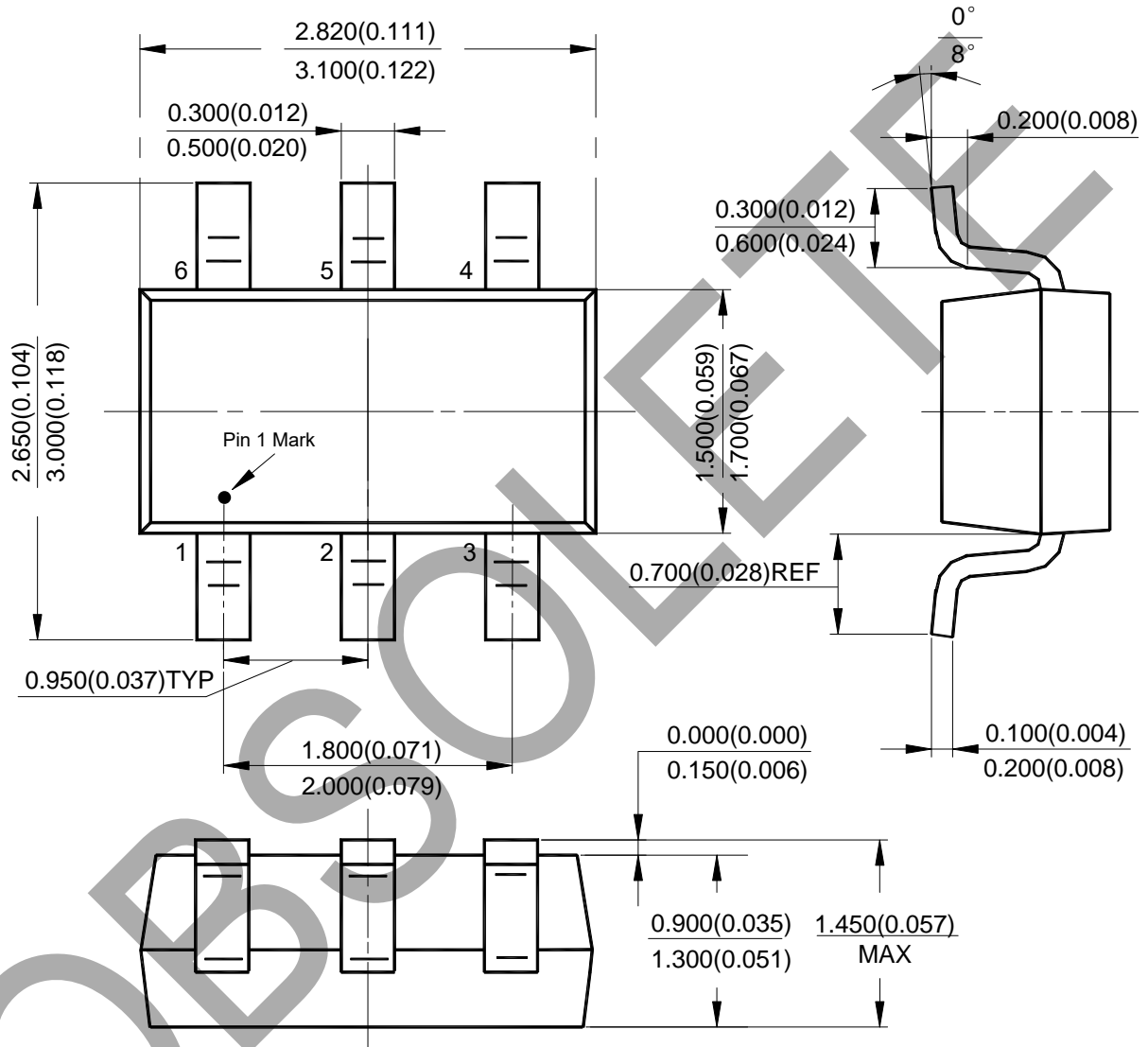


: Logo

XXX: Marking ID (See Ordering Information)

**Package Outline Dimensions** (All dimensions in mm(inch).)

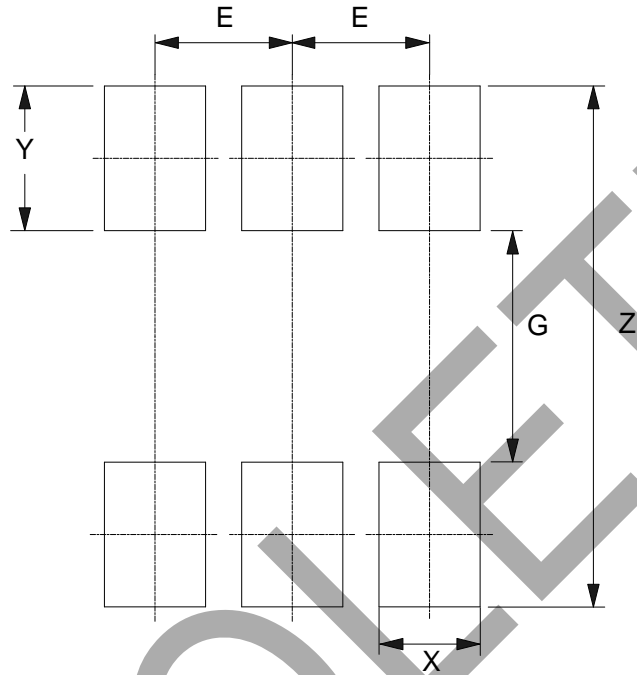
 Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**(1) Package Type: SOT26**


## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SOT26



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037

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